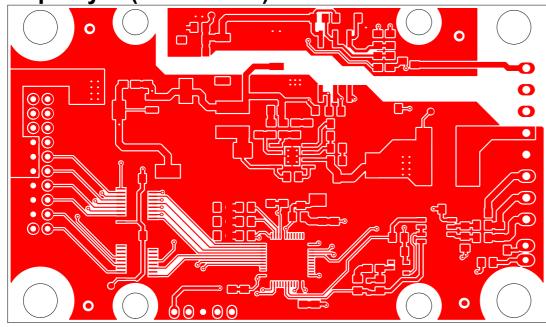
İçindekiler / Contents

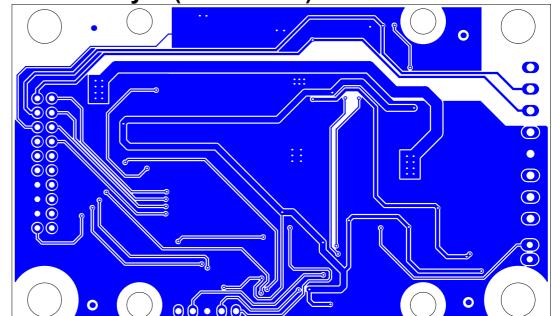
Sayfa No / page number	Açıklama / Description
1	İçindekiler / Contents
2	Bakır Katmanları / Copper Layers
3	Baskı Katmanları / Overlay Layers
4	Lehim Katmanları / Solder Layer
5	Delik Tablosu ve Çizimi / Drill Table and Drawing
6	Katman Tasarımı / Stack-Up Design

Kont/Check Hamit Can Dinç	Tanim/Description	Stok No/ Stock Number						
Haz/Prep	PFC CONTROL BOA	-						
Hamit Can Dinç						Rev		
						1		
		Syfnin/Shts /			Deg Onay/Change Appr	Deg Tarihi/Chng Date	Form	
	Altium Designer	1 /	6	28.06.2024	Hamit Can	28.06.2024	A3	

Top Layer (Scale 1.5:1)

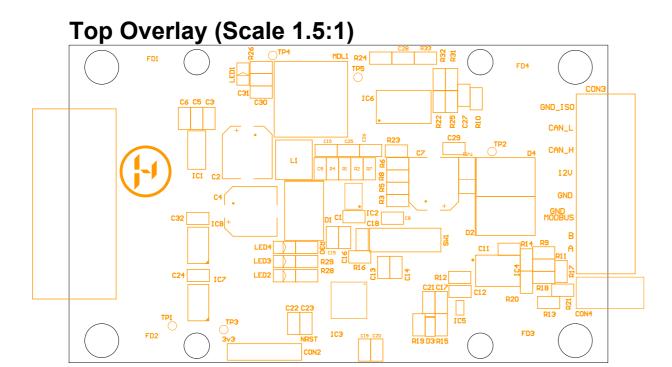


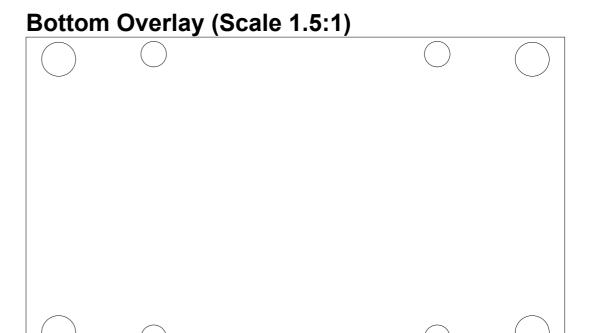




No	Açıklama / Description

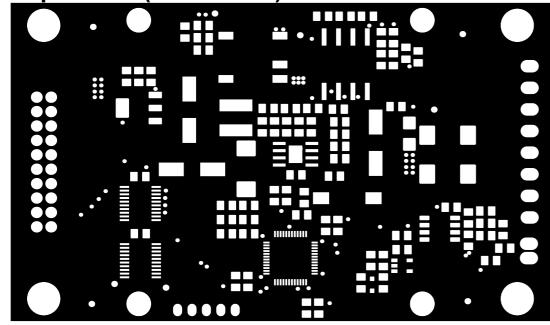
Kont/Check Hamit Can Dinç	Tanim/Description	Stok No/ Stock Number				
Haz/Prep Hamit Can Dinc	PFC CONTROL BOA	-				
•		Rev 1				
	Ortam/Env Altium Designer	Syfnin/Shts / Sayfasi/Sht 2 / 6	Tarih/Date 28.06.2024	Deg Onay/Change Appr Hamit Can	Deg Tarihi/Chng Date 28.06.2024	Form A3



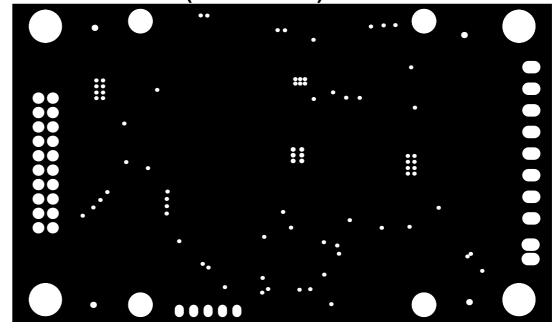


No	Açıklama / Description

Kont/Check Hamit Can Dinç	Tanim/Description	Stok No/ Stock Number					
Haz/Prep Hamit Can Dinc	PFC CONTROL BOA	RD	-				
Hamil Can Ding	Ī					Rev	
	Ortam/Env Altium Designer	Syfnin/Shts / 3	Sayfasi/Sht	Tarih/Date	Deg Onay/Change Appr Hamit Can	Deg Tarihi/Chng Date 28.06.2024	Form A3



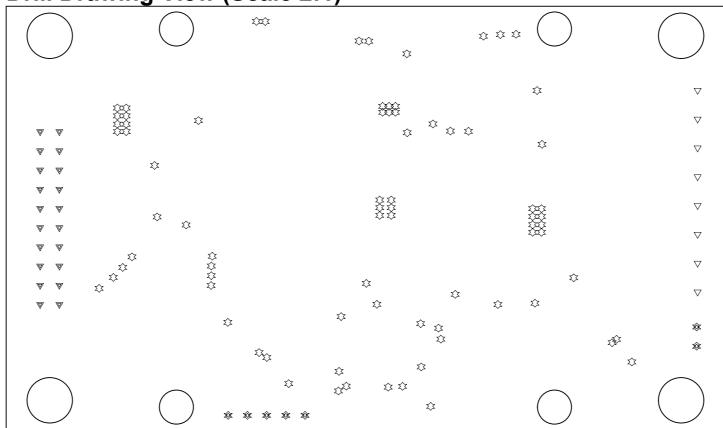
Bottom Solder (Scale 1.5:1)



No	Açıklama / Description

Kont/Check Hamit Can Dinç	Tanim/Description		Stok No/ Stock Number				
Haz/Prep Hamit Can Dinc	PFC CONTROL BOA	PFC CONTROL BOARD					
Hamit Oan Ding	1						
					1		
	Ortam/Env Altium Designer	Syfnin/Shts / Sayfasi/Sht 4 / 6	Tarih/Date 28.06.2024	Deg Onay/Change Appr Hamit Can	Deg Tarihi/Chng Date 28.06.2024	Form A3	

Drill Drawing View (Scale 2:1)



Delik Tablosu / Drill Table

Symbol	Count	Hole Size	Plated	Hole Type	Via / Pad	Pad Shape	Template	Hole Tolerance
\$	78	0.30mm(11.81mil)	Plated	Round	Via		(Mixed)	
₩	20	1.02mm(40.16mil)	Plated	Round	Pad	Rounded	c180h102	
*	7	1.10mm(43.31mil)	Plated	Round	Pad	Rounded	(Mixed)	
∇	8	1.40mm(55.12mil)	Plated	Round	Pad	Rounded	r200_300h140r100	
	113 Total							

No	Açıklama / Description

Kont/Check Hamit Can Dinç	Tanim/Description	Stok No/ Stock Number					
Haz/Prep Hamit Can Dinc	PFC CONTROL BOA	-					
						Rev 1	
	Ortam/Env Altium Designer	Syfnin/Shts /		Tarih/Date		Deg Tarihi/Chng Date	Form A3

Katman Tasarımı / Stack-Up Design

Layer Stack Legend

	Material	Layer	Thickness	Dielectric Material	Туре	Gerber
	/	Top Overlay			Legend	GTO
	Surface Material	Top Solder	0.03mm(1.00mil)	SM-001	Solder Mask	GTS
X: X///////////////////////////////////	PbSn	Top Surface Finish	0.02mm(0.79mil)		Surface Finish	
A	CF-004	Top Layer	0.04mm(1.38mil)		Signal	GTL
	Core		1.50mm(59.00mil)	Core-043	Dielectric	
	CF-004	Bottom Layer	0.04mm(1.38mil)		Signal	GBL
	PbSn	Bottom Surface Finish	0.02mm(0.79mil)		Surface Finish	
	Surface Material	Bottom Solder	0.03mm(1.00mil)	SM-001	Solder Mask	GBS
	1	Bottom Overlay			Legend	GBO

Total thickness: 1.66mm(65.33mil)

Board ID:	PEU RELAY CONTROL BOARD				
Quantity:	20				
Dimensions [mm]:	56x95 mm				
Layers:	2				
Substrate:	FR-4, Tg:150-160				
Total Thickness:	1.6mm				
Copper Weight:	Top/Bottom: 1 Oz				
Surface Finish:	LeadFree HASL				
Controlled Impedance:	No				
Panel Separating Way:	No				
Number of Different Boards:	1				
Via Process:	Tented, Filled w/Resin				
Solder Mask Color:	Green				
Silkscreen Color:	White				
Minimum Hole Size [mm]:	0,30mm				
Minimum Clearance / Spacing [mm]:	0.2mm				
V-CUT:	Yes				
Via Fill:	Yes				
Additional Notes:	Class-2				

No	Açıklama / Description				
1	PCB üretimi yukarıdaki tablo referans alınarak yapılmalıdır!				

Kont/Check Hamit Can Dinç	Tanim/Description	Stok No/ Stock Number			
Haz/Prep Hamit Can Dinc	PFC CONTROL BOA	-			
				Rev 1	
	Ortam/Env Altium Designer		Deg Onay/Change Appr Hamit Can	Deg Tarihi/Chng Date 28.06.2024	Form A3